

Appl. No. 10/620,636  
Amdt Dated May. 25, 2005  
Reply to Office Action February 25, 2005

### **REMARKS**

Claims 1-8 and 10-17 are rejected under 35 U.S.C. 102(e) as being anticipated by Hsien (U.S. 6,655,449). Claim 9 is rejected under 35 U.S.C. 103(a) as being unpatentable over Hsien (U.S. 6,655,449) in view of Calaman et al. (U.S. 6,719,039).

Applicant cancels claim 10, amends claims 1, 3, 11, keeps claims 2, 4-9, 12-17 unchanged, and adds new claims 18-21.

Hsien did teach a cooling device in which the posts 3 are evenly distributed in the whole of the casing 2. The inlet and the outlet are formed at the cover 4.

Amended claim 1 defines a cooling device in which the pins are merely around a center portion of the tank. The inlet and the outlet are formed at the tank instead of the cover. The cooling device of amended claim 1 is different in comparison with the Hsien reference, and not anticipated by Hsien reference; thus amended claim 1 should be allowable.

Claims 2-9 depend from claim 1, and should also be allowable.

Amended claim 11 points out that the base of the tank defines holes at periphery thereof for positioning of the tank, the cover seals the tank opposite to said base. This feature is not taught by Hsien reference. Thus, Hsien reference NOT teaches every element of the invention described in amended claim 11. Therefore, amended claim 11 is not anticipated by Hsien reference and should be allowable.

Newly added claim 18 points out that the holes defined in the base around the sidewalls for positioning the tank. This feature is novel in comparison with the references cited by the Examiner and should be given great patentable weight.

Appl. No. 10/620,636  
Amdt Dated May. 25, 2005  
Reply to Office Action February 25, 2005

Newly added claim 19 points out that the inlet and the outlet extend outward from opposite extremities of the channel and along a direction parallel to the base. This feature is also novel in comparison with the reference cited by the Examiner and should be given great patentable weight.

The newly added claims 20 and 21 relate to Hsien and Frey. Anyhow, Applicant will supplementally submit, in few days, the declaration under 3.131 to antedate the Hsien reference. Without Hsien, Frey no longer anticipates or renders obvious claims 20 and 21.

In view of the foregoing, the subject application as claimed in the pending claims is in a condition for allowance and an action to such effect is earnestly solicited.

Respectfully submitted,

Lee et al.

By 

Wei Te Chung

Registration No.: 43,325

Foxconn International, Inc.

P. O. Address: 1650 Memorex Drive, Santa Clara, CA 95050

Tel No.: (408) 919-6137